

Features

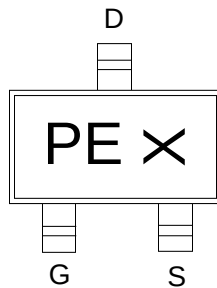
- Advanced trench cell design
- High speed switch
- ESD protected up to 2KV

Product Summary

V_{DS}	$R_{DS(ON)}$ TYP	I_D
-60V	3.6Ω@-10V	-0.13A
	4.0Ω@-4.5V	

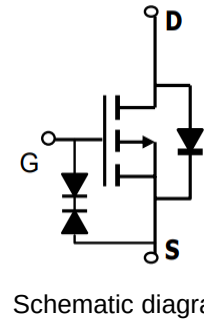
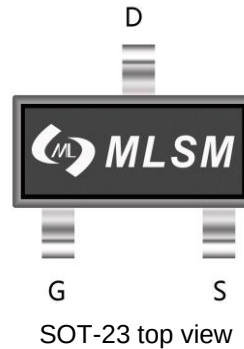
Application

- Portable appliances
- Load switch appliances



PE: Device code
X : Code

Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	-60	V
V_{GS}	Gate-Source Voltage	±20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	Tc=25°C -0.13	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	Tc=25°C -0.65	A
I_D	Continuous Drain Current	Tc=25°C -0.13	A
P_D	Maximum Power Dissipation	Tc=25°C 0.35	W
ESD	Gate-Source ESD Rating (HBM, Method 3015)	2000	V

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
BSS84K	SOT-23	PE	3,000	45,000	180,000	7" reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±10	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	--	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-0.13A	--	3.6	5.3	Ω
		V _{GS} =-4.5V, I _D =-0.1A	--	4.0	6.4	Ω
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-25V, V _{GS} =0V, f=1MHz	--	25.2	--	pF
C _{OSS}	Output Capacitance		--	5.9	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	1.4	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-30V, I _D =-0.1A, V _{GS} =-10V	--	0.53	--	nC
Q _{gs}	Gate Source Charge		--	0.14	--	nC
Q _{gd}	Gate Drain Charge		--	0.1	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-30V, I _D =-0.1A, V _{GS} =-10V, R _G =3.3Ω	--	1.6	--	nS
t _r	Turn-on Rise Time		--	5.2	--	nS
t _{d(off)}	Turn-Off Delay Time		--	12	--	nS
t _f	Turn-Off Fall Time		--	6.1	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	Tj=25°C, Is=-0.13A	--	--	-1.2	V

Typical Operating Characteristics

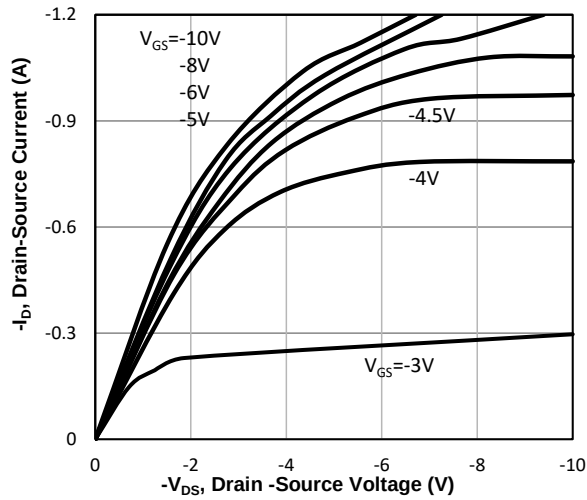


Fig1. Typical Output Characteristics

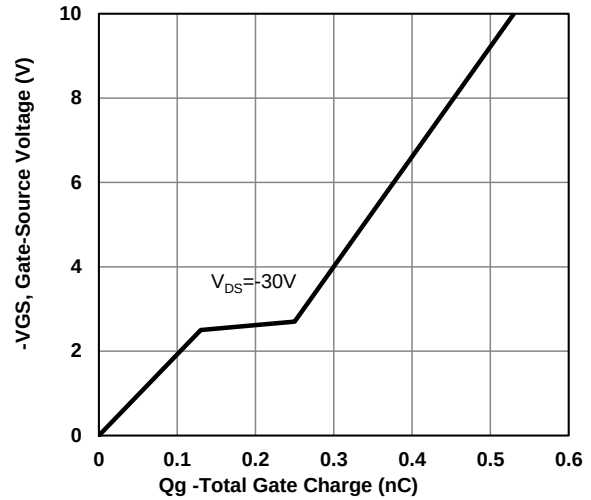


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

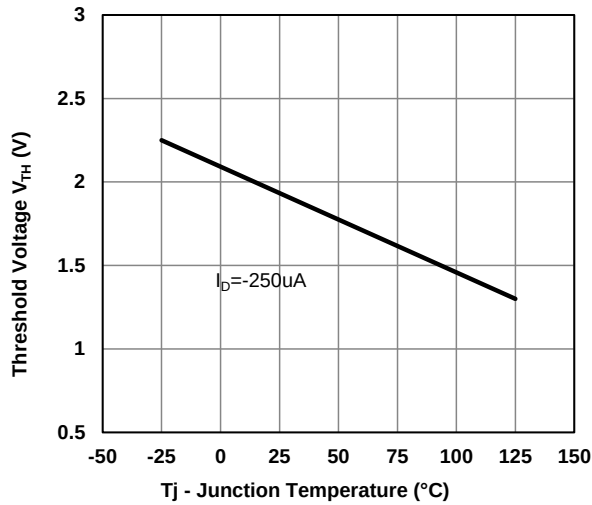


Fig3. Normalized On-Resistance Vs. Temperature

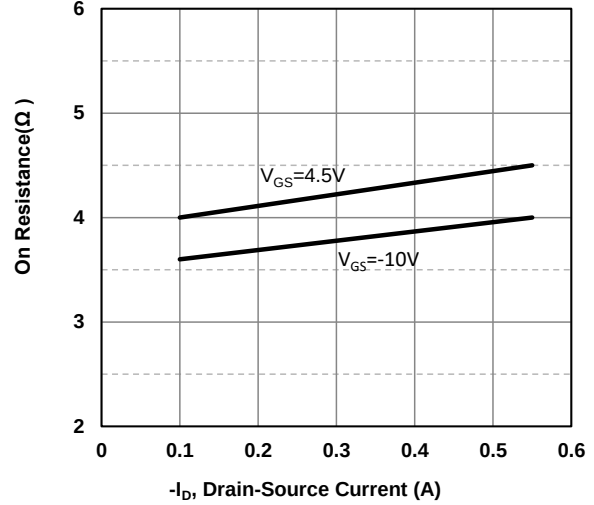


Fig4. On-Resistance Vs. Drain-Source Current

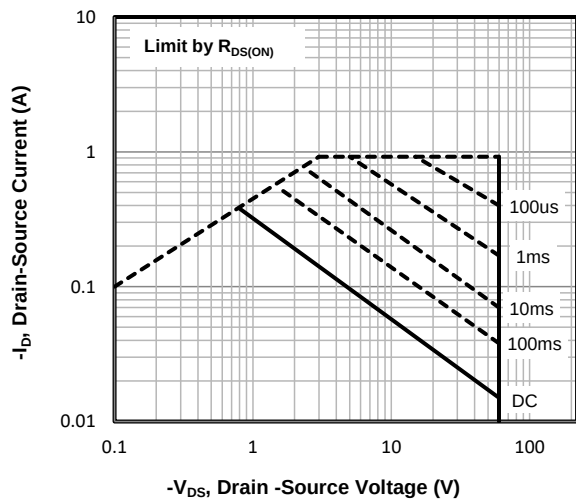


Fig5. Maximum Safe Operating Area

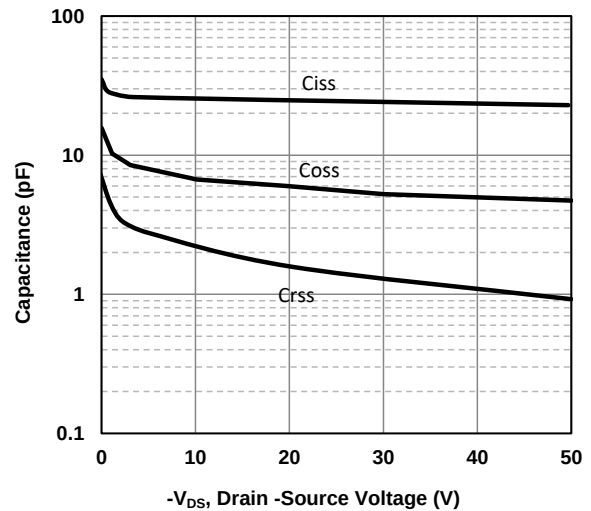
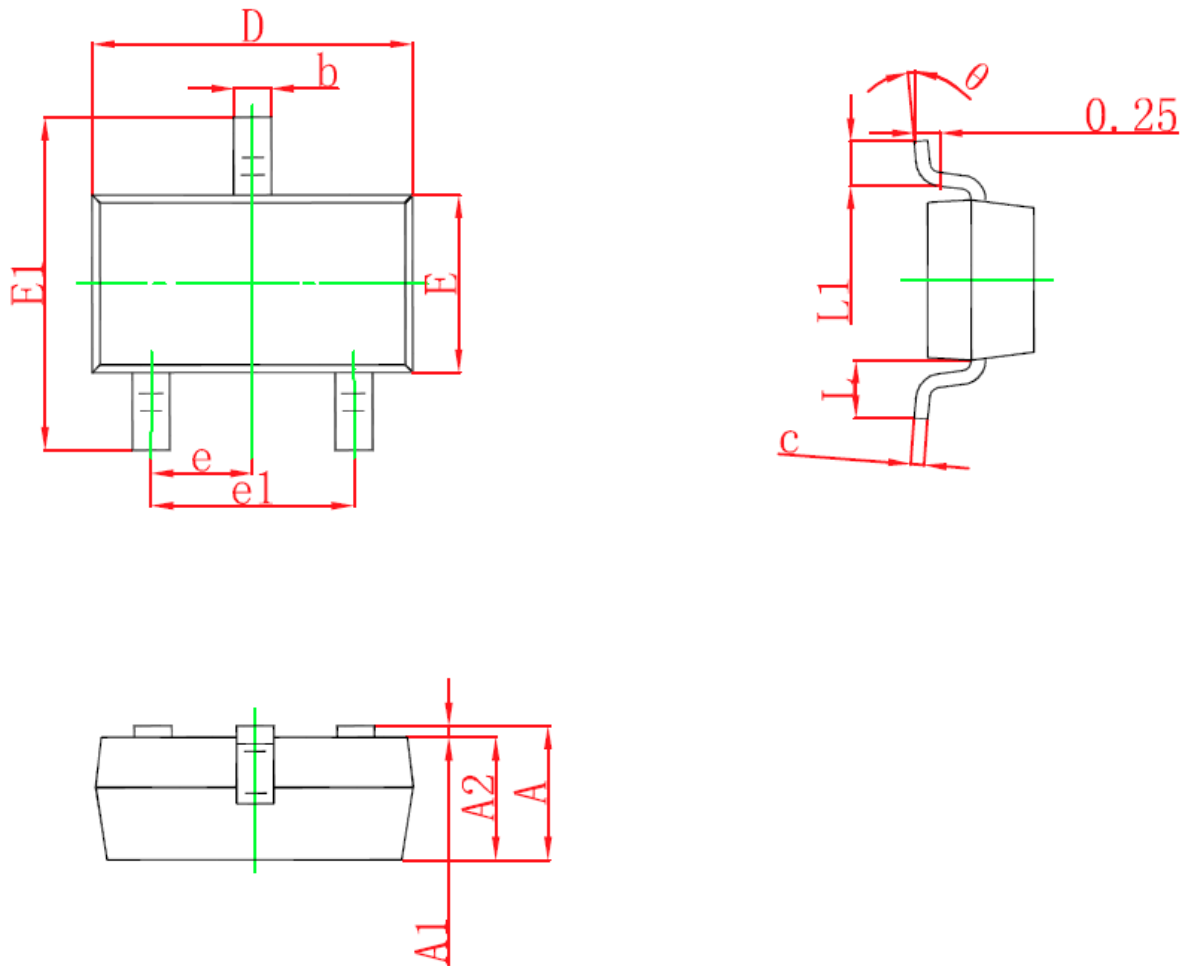


Fig6 Typical Capacitance Vs. Drain-Source Voltage

SOT-23 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E1	2.250	2.550	0.088	0.100
E	1.200	1.400	0.047	0.055
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°